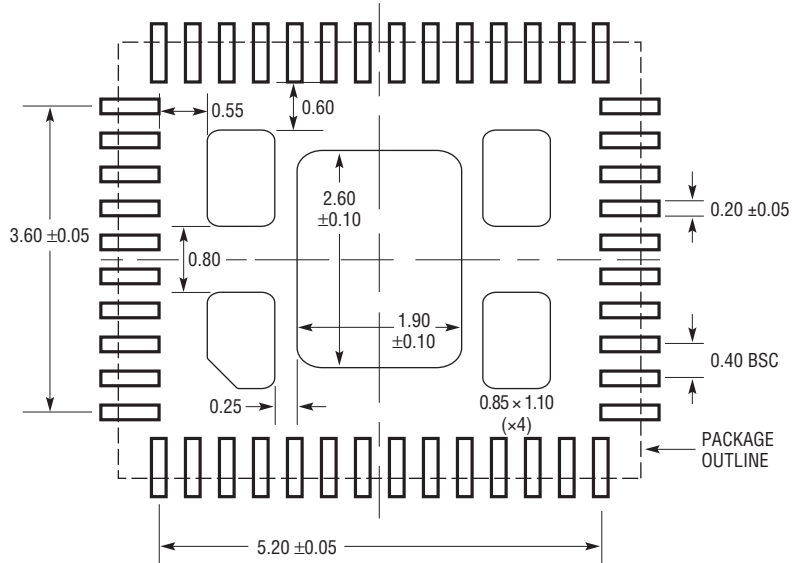
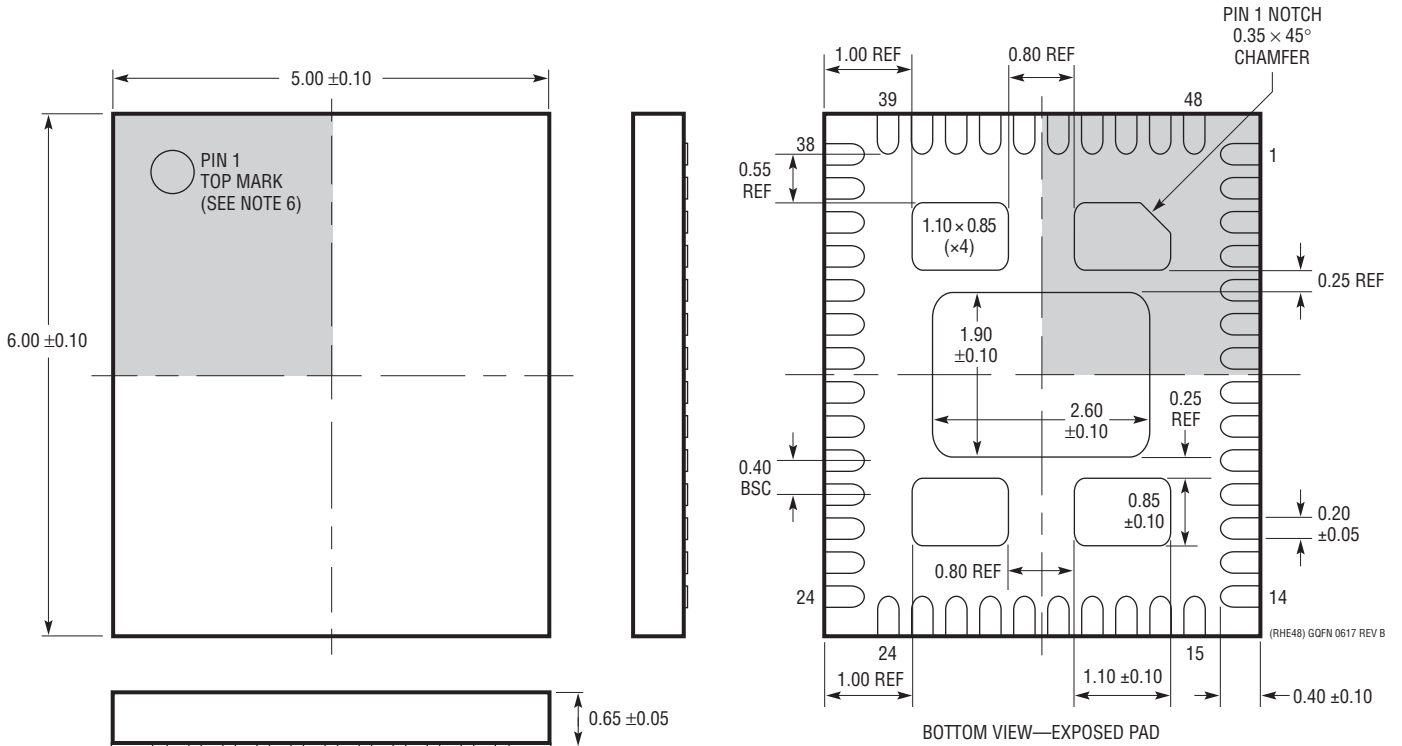


**RHE Package**  
**48-Lead Plastic GQFN (5mm × 6mm)**  
 (Reference LTC DWG # 05-08-1527 Rev B)



RECOMMENDED SOLDER PAD LAYOUT  
 APPLY SOLDER MASK TO AREAS THAT ARE NOT SOLDERED



NOTE:  
 1. DRAWING IS NOT A JEDEC PACKAGE OUTLINE  
 2. DRAWING NOT TO SCALE  
 3. ALL DIMENSIONS ARE IN MILLIMETERS

4. DIMENSIONS OF EXPOSED PAD ON BOTTOM OF PACKAGE DO NOT INCLUDE MOLD FLASH. MOLD FLASH, IF PRESENT, SHALL NOT EXCEED 0.25mm ON ANY SIDE  
 5. EXPOSED PAD SHALL BE Pd Ni Au PLATED  
 6. SHADED AREA IS ONLY A REFERENCE FOR PIN 1 LOCATION ON THE TOP AND BOTTOM OF PACKAGE

(RHE48) GQFN 0617 REV B